

Electrostatic Discharged Protection Devices (ESD) Data Sheet

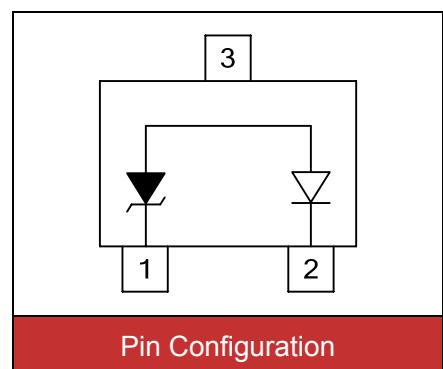
Description

Brightking's UDT23AXXL01 series are ultra low capacitance TVS arrays designed to protect high speed data interfaces. This series has been specifically designed to protect sensitive components which are connected to high-speed data and transmission lines from overvoltage caused by electrostatic discharge (ESD), cable discharge events(CDE) and electrical fast transients(EFT).The series has a maximum capacitance of only 1.2pF. This means it can be used on circuits operating in excess of 3GHz without signal attenuation.



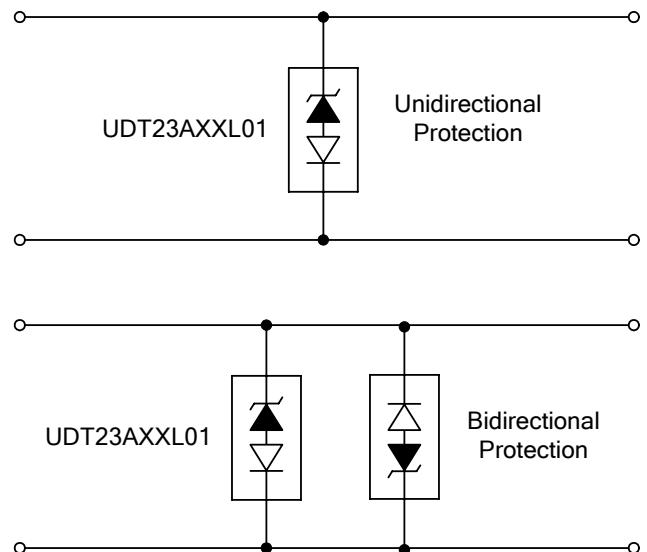
Features

- IEC61000-4-2 ESD 15KV Air, 8KV contact compliance
- SOT-23 surface mount package
- Protects one high speed data line
- Peak power dissipation of 400W under 8/20 μ s waveform
- Working voltage: 3.3V, 5V, 12V, 15V and 24V
- Low leakage current
- Ultra low capacitance and clamping voltage
- Solid-state silicon avalanche technology
- Lead Free/RoHS compliant
- Solder reflow temperature: Pure Tin-Sn, 260~270°C
- Flammability rating UL 94V-0
- Meets MSL level 1, per J-STD-020



Applications

- HDMI interface protection
- Mobile display digital interface
- RF/Antenna circuits
- USB 2.0 & Firewire ports
- GaAs photodetector protection
- HBT power Amp protection
- Infiniband transceiver protection



Maximum Ratings

Rating	Symbol	Value	Unit
Peak pulse power ($tp=8/20\mu s$ waveform)	P_{PP}	400	W
ESD voltage (Contact discharge)	V_{ESD}	± 8	kV
ESD voltage (Air discharge)		± 15	
Storage & operating temperature range	T_{STG}, T_J	-55~+150	°C

Electrical Characteristics ($T_J=25^\circ C$)

UDT23A03L01 (Marking: B SJ)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Reverse stand-off voltage	V_{RWM}				3.3	V
Reverse breakdown voltage	V_{BR}	$I_{BR}=1mA$	4			V
Reverse leakage current	I_R	$V_R=3.3V$			50	μA
Clamping voltage ($tp=8/20\mu s$)	V_C	$I_{PP}=1A$			8	V
Clamping voltage ($tp=8/20\mu s$)	V_C	$I_{PP}=5A$			10	V
Off state junction capacitance	C_J	0Vdc, $f=1MHz$ Between I/O pins and GND			1.2	pF

UDT23A05L01 (Marking: B SK)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Reverse stand-off voltage	V_{RWM}				5	V
Reverse breakdown voltage	V_{BR}	$I_{BR}=1mA$	6			V
Reverse leakage current	I_R	$V_R=5V$			5	μA
Clamping voltage ($tp=8/20\mu s$)	V_C	$I_{PP}=1A$			9.5	V
Clamping voltage ($tp=8/20\mu s$)	V_C	$I_{PP}=5A$			12	V
Off state junction capacitance	C_J	0Vdc, $f=1MHz$ Between I/O pins and GND			1.2	pF

Electrical Characteristics ($T_J=25^\circ\text{C}$)

UDT23A12L01 (Marking: B SL)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Reverse stand-off voltage	V_{RWM}				12	V
Reverse breakdown voltage	V_{BR}	$I_{BR}=1\text{mA}$	13.3			V
Reverse leakage current	I_R	$V_R=12\text{V}$			1	μA
Clamping voltage ($tp=8/20\mu\text{s}$)	V_C	$I_{PP}=1\text{A}$			19	V
Clamping voltage ($tp=8/20\mu\text{s}$)	V_C	$I_{PP}=5\text{A}$			24	V
Off state junction capacitance	C_J	0Vdc, $f=1\text{MHz}$ Between I/O pins and GND			1.2	pF

UDT23A15L01 (Marking: B SM)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Reverse stand-off voltage	V_{RWM}				15	V
Reverse breakdown voltage	V_{BR}	$I_{BR}=1\text{mA}$	16.7			V
Reverse leakage current	I_R	$V_R=15\text{V}$			1	μA
Clamping voltage ($tp=8/20\mu\text{s}$)	V_C	$I_{PP}=1\text{A}$			24	V
Clamping voltage ($tp=8/20\mu\text{s}$)	V_C	$I_{PP}=5\text{A}$			30	V
Off state junction capacitance	C_J	0Vdc, $f=1\text{MHz}$ Between I/O pins and GND			1.2	pF

UDT23A24L01 (Marking: B SN)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Reverse stand-off voltage	V_{RWM}				24	V
Reverse breakdown voltage	V_{BR}	$I_{BR}=1\text{mA}$	26.7			V
Reverse leakage current	I_R	$V_R=24\text{V}$			1	μA
Clamping voltage ($tp=8/20\mu\text{s}$)	V_C	$I_{PP}=1\text{A}$			43	V
Clamping voltage ($tp=8/20\mu\text{s}$)	V_C	$I_{PP}=5\text{A}$			55	V
Off state junction capacitance	C_J	0Vdc, $f=1\text{MHz}$ Between I/O pins and GND			1.2	pF

Typical Characteristics Curves

Figure 1. Power Derating Curve

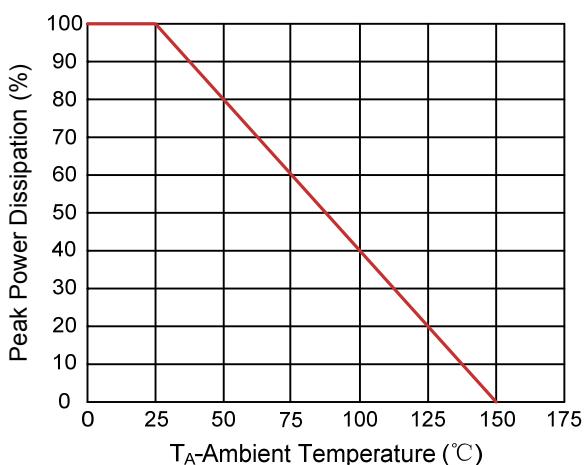


Figure 2. Pulse Waveforms

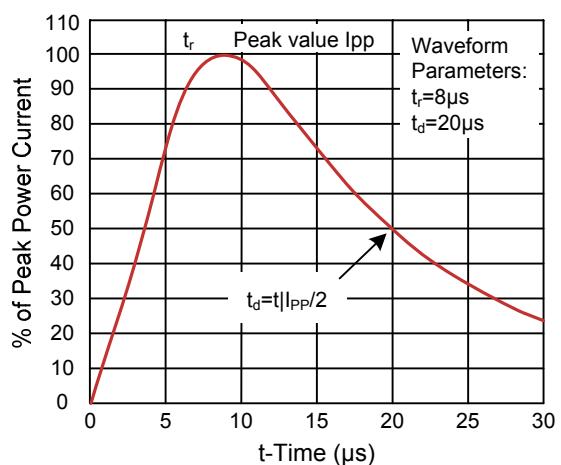


Figure 3. Non-Repetitive Peak Pulse vs. Pulse Time

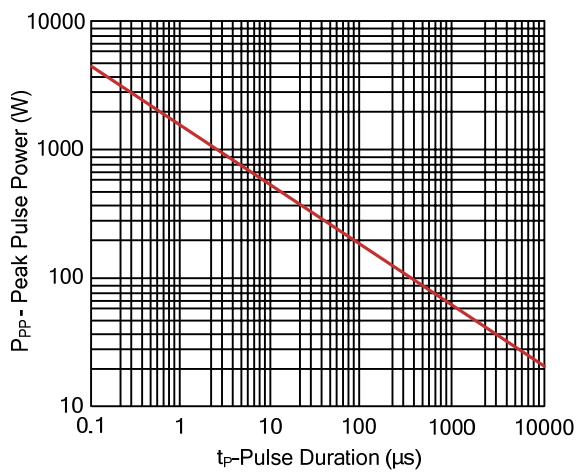
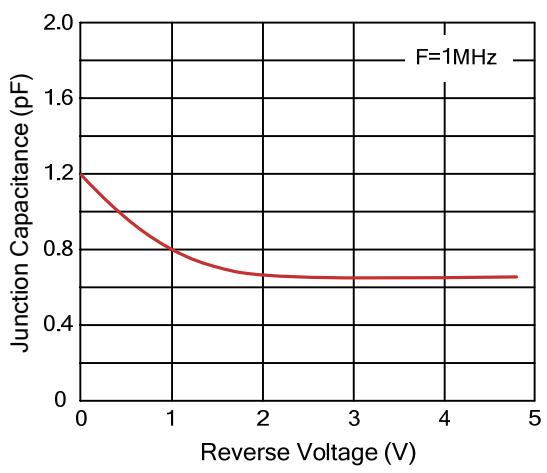
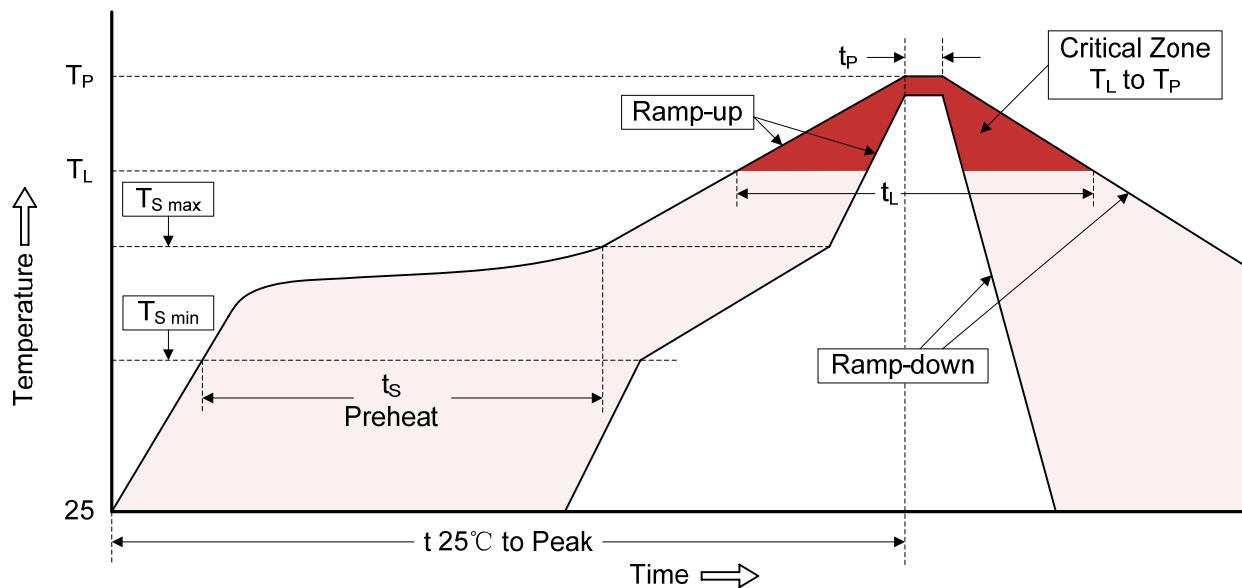


Figure 4. Capacitance vs. Reverse Voltage



Recommended Soldering Conditions

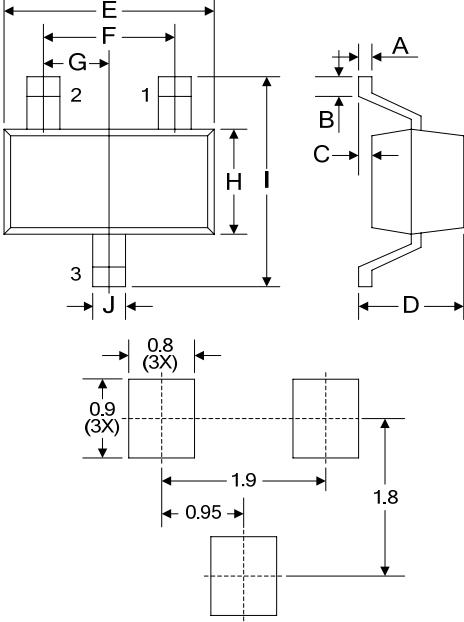
Reflow Soldering



Recommended Conditions

Profile Feature	Pb-Free Assembly
Average ramp-up rate (T_L to T_P)	3°C/second max.
Preheat	
- Temperature Min ($T_{S\ min}$)	150°C
- Temperature Max ($T_{S\ max}$)	200°C
- Time (min to max) (t_s)	60-180 seconds
$T_{S\ max}$ to T_L	
- Ramp-up Rate	3°C/second max.
Time maintained above:	
- Temperature (T_L)	217°C
- Time (t_L)	60-150 seconds
Peak Temperature (T_P)	260°C
Time within 5°C of actual Peak Temperature (t_P)	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

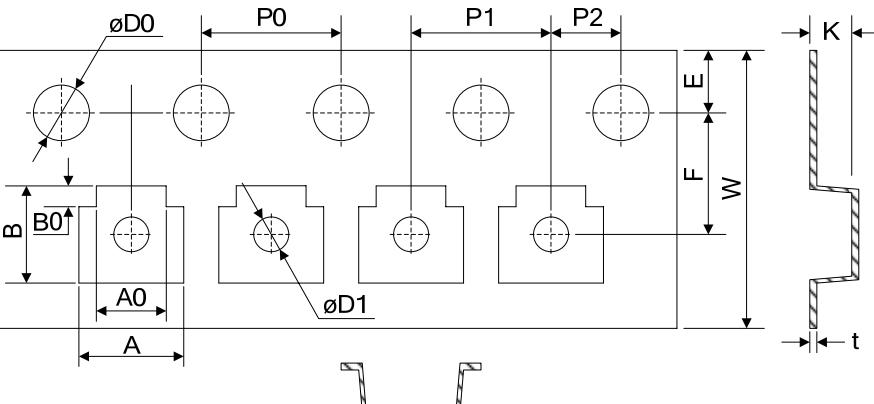
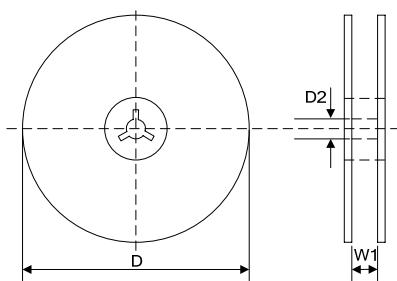
Dimensions (SOT-23)



The technical drawing shows the physical dimensions of the SOT-23 package. It includes top and side views with labeled dimensions A through J. Below the main drawing is a detailed 'Recommended Soldering Pad Layout' showing the placement of three pads on the bottom surface.

Symbol	Dimension			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	0.08	0.18	0.003	0.007
B	0.15	-	0.006	-
C	-	0.13	-	0.005
D	0.89	1.09	0.035	0.043
E	2.80	3.05	0.110	0.120
F	1.90		0.075	
G	0.95		0.037	
H	1.19	1.40	0.047	0.055
I	2.10	2.49	0.083	0.098
J	0.35	0.50	0.014	0.020

Packaging

Tape	 <p>The technical drawing shows the dimensions for a tape used in reflow soldering. It includes top and side views with labeled dimensions A through K. The top view shows the pitch (P0, P1, P2) between pads, the width (W) of the tape, and the height (E) of the tape. The side view shows the thickness (t) and the height (K) of the tape. The bottom view shows the reel configuration with dimensions D0, D1, and A0.</p>	<table border="1"> <thead> <tr> <th>Symbol</th> <th>Dimension (mm)</th> </tr> </thead> <tbody> <tr> <td>W</td> <td>8.00±0.30</td> </tr> <tr> <td>P0</td> <td>4.00±0.10</td> </tr> <tr> <td>P1</td> <td>4.00±0.10</td> </tr> <tr> <td>P2</td> <td>2.00±0.10</td> </tr> <tr> <td>D0</td> <td>Φ1.55±0.10</td> </tr> <tr> <td>D1</td> <td>Φ1.00±0.05</td> </tr> <tr> <td>E</td> <td>1.75±0.10</td> </tr> <tr> <td>F</td> <td>3.50±0.10</td> </tr> <tr> <td>A</td> <td>3.10±0.10</td> </tr> <tr> <td>A0</td> <td>2.10±0.10</td> </tr> <tr> <td>B</td> <td>2.75±0.10</td> </tr> <tr> <td>B0</td> <td>0.65±0.10</td> </tr> <tr> <td>K</td> <td>1.10±0.10</td> </tr> <tr> <td>t</td> <td>0.20±0.05</td> </tr> </tbody> </table>	Symbol	Dimension (mm)	W	8.00±0.30	P0	4.00±0.10	P1	4.00±0.10	P2	2.00±0.10	D0	Φ1.55±0.10	D1	Φ1.00±0.05	E	1.75±0.10	F	3.50±0.10	A	3.10±0.10	A0	2.10±0.10	B	2.75±0.10	B0	0.65±0.10	K	1.10±0.10	t	0.20±0.05
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Reel	 <p>The technical drawing shows the dimensions for a reel holding the tape. It includes a top view of the reel with diameter D and a side view of the reel core with height W1 and outer diameter D2.</p>	<table border="1"> <tbody> <tr> <td>D</td> <td>Φ178.0±2.0</td> </tr> <tr> <td>D2</td> <td>Φ13.0</td> </tr> <tr> <td>W1</td> <td>9.5</td> </tr> <tr> <td>Quantity:</td> <td>3000PCS</td> </tr> </tbody> </table>	D	Φ178.0±2.0	D2	Φ13.0	W1	9.5	Quantity:	3000PCS																						
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